

# SM16703P

## Feature

- Synchronous refresh
- High-voltage CMOS technology
- Input voltage: 5~24V@LDO circuit
- OUT withstand voltage: 26V
- Gray scale adjustment circuit (256 levels)
- White LED when powered on (default)
- Output 17mA constant current (default)
- Single-line cascade transmission port (DIN, DOUT)
- Built-in high-precision and high-stability oscillator
- Data Reshape: Automatic data reshape output after receiving the unit data
- Data transmission speed: 800Kbps
- Package: SOP8

## Application

- Interior LED decorative lighting
- Architectural LED exterior/scene lighting
- Wash-wall lamp, curtain screen
- Luminous character
- Guardrail tube

## Description

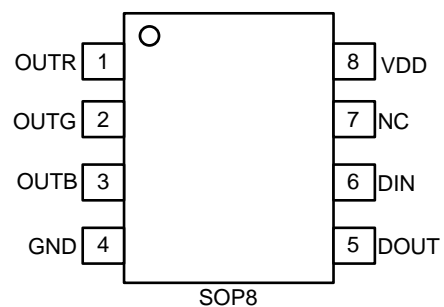
The SM16703P is a single-line transmission tri-channel LED driver, which adopts single-polarity RZ communication protocol.

The chip integrates LDO circuit, signal decoding module, data register, constant current circuit and RC oscillator, and the output drive adopts the patented SPWM technology.

## Order Information

Type	Package	Packing		Reel Size
		Tube	Tape	
SM16703P	SOP8	100 pcs/tube	3500 pcs/tape	13 inches

## Pin Definition



**Pin Definition**

Symbol	Pin Name	Pin No.	Pin Description
OUTR	Output port	1	RED output port
OUTG	Output port	2	GREEN output port
OUTB	Output port	3	BLUE output port
GND	Ground	4	Ground
DOUT	Data output	5	Data output port, used in cascade
DIN	Data input	6	Data input port
NC	No connection	7	No connection
VDD	Chip Power	8	Chip Power

**Electric Parameter**Absolute Maximum Parameter ( $T_a = 25^\circ\text{C}$ )

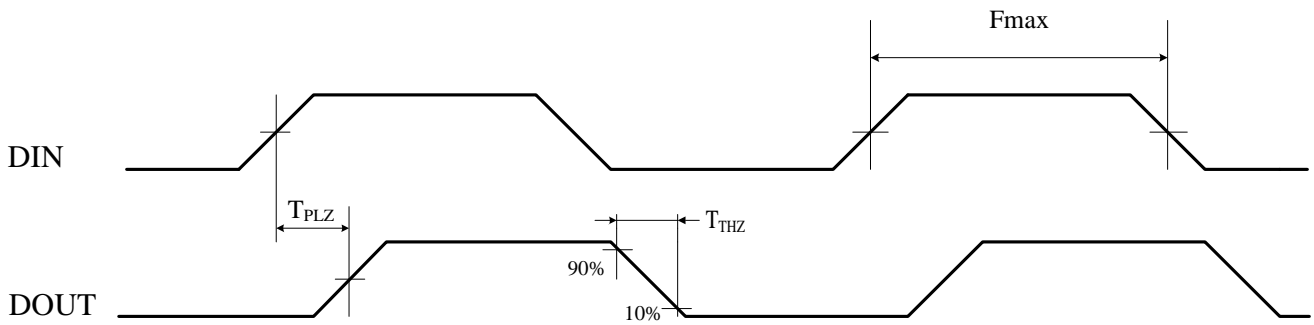
Parameter	Symbol	Range	Unit
Input voltage	$V_{IN}$	5—24	V
R/G/B current output port withstand voltage	$V_{DS}$	26	V
Logic	$V_{I1}$	-0.5—5.5	V
R/G/B output current	$I_{OL1}$	17	mA
Power consumption	PD	550	mW
Operating temperature	$T_{OPT}$	-40—+85	$^\circ\text{C}$
Storage temperature	$T_{STG}$	-50—+150	$^\circ\text{C}$
ESD withstand voltage	$V_{ESD}$	8K	V

## Electric Characteristic (Ta = 25°C)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Chip input voltage	V <sub>IN</sub>	-	-	5	24	V
Chip internal power & voltage	VDD	-	-	5.2	-	V
R/G/B withstand voltage	V <sub>DS,MAX</sub>	OUT R/G/B	-	-	26	V
R/G/B drive current	I <sub>OUT,R</sub>	V <sub>DS,R</sub> =1V	-	17	-	mA
DOUT drive capability	I <sub>DOH</sub>	DOUT short connects to ground, max. drive current	-	49	-	mA
	I <sub>DOL</sub>	DOUT short connects to VDD, max. sink current	-	-50	-	mA
Data input flip threshold value	V <sub>IH</sub>	VDD=5.0V	-	3.4	-	V
	V <sub>IL</sub>		-	1.6	-	V
R/G/B current variation	%VS.V <sub>DS</sub>	V <sub>DS</sub> =1~5V, I <sub>OUT</sub> =17 mA	-	0.5	-	%
	%VS.VDD	VDD=1~5V, I <sub>OUT</sub> =17 mA	-	0.3	-	%
	%VS.Tem.	V <sub>DS</sub> =1~5V, I <sub>OUT</sub> =17 mA, Tem.= -40~+85°C	-	4.0	-	%
R/G/B voltage	V <sub>DS</sub>	I <sub>OUT</sub> =17 mA	0.8	-	-	V
PWM frequency	f <sub>PWM</sub>	-	-	1.2	-	KHZ
Quiescent power consumption	I <sub>DD</sub>	- I <sub>OUT</sub> "OFF"	-	2.0	-	mA

## Dynamic Parameter (Ta = 25°C)

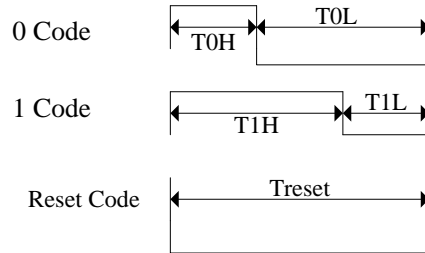
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Data transmission speed	f <sub>DIN</sub>	Duty ratio 67% (data 1)	-	800	-	KHZ
DOUT transmission delay	t <sub>PLZ</sub>	DIN→DOUT	-	-	500	ns
	t <sub>PLZ</sub>		-	-	500	ns
I <sub>OUT</sub> rise time	T <sub>r</sub>	V <sub>DS</sub> =1.5	-	32	-	ns
	T <sub>f</sub>	I <sub>OUT</sub> =17mA	-	27	-	ns



### Code Description

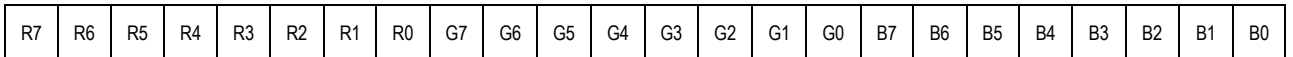
The protocol of the chip adopts single polarity RZ code, LOW level must be contained in each code element. Each code element in the protocol initiates with HIGH level, and the width of the HIGH level time determines 0 code or 1 code.

#### Input Code:



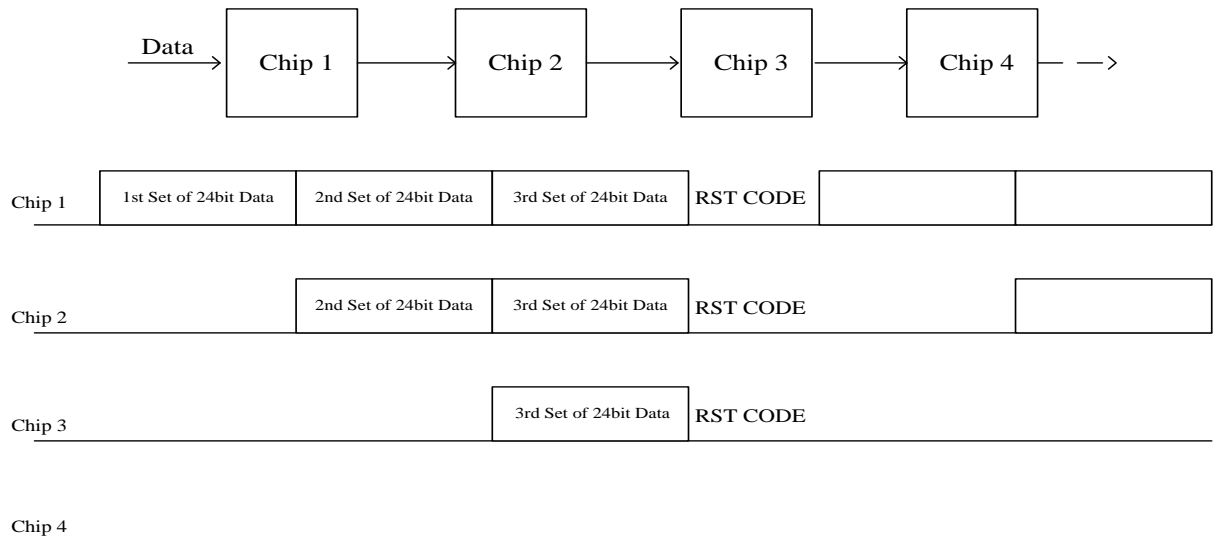
Name	Description	Min.	Typ.	Max.	Allowable error	Unit
T0H	0, HIGH level	-	0.3	-	±0.05	us
T1H	1, HIGH level	-	0.9	-	±0.05	us
T0L	0, LOW level	-	0.9	-	±0.05	us
T1L	1, LOW level	-	0.3	-	±0.05	us
Trst	Reset, LOW level	-	80	-	-	us

RGB data transmission in high-order:



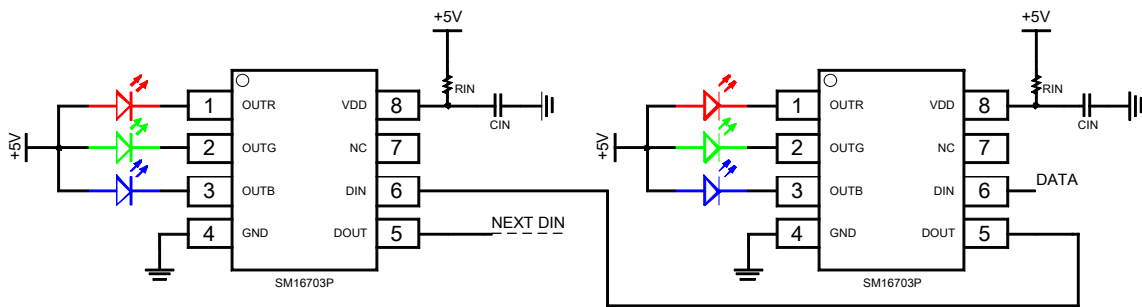
bit23.....bit0

DIN format: Trst+1<sup>st</sup> chip 24bit gray scale data+2<sup>nd</sup> chip 24bit gray scale+.....+Nth chip 24bit gray scale



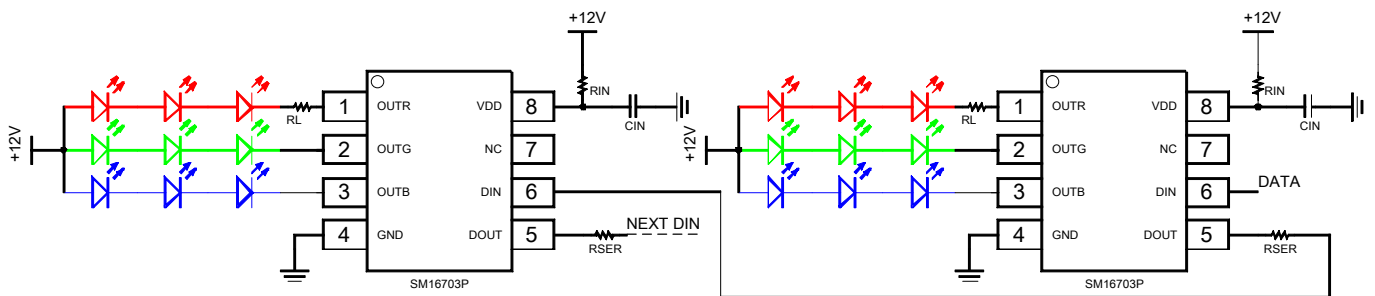
### Typical Application Circuit

(1) 5V power supply, single LED



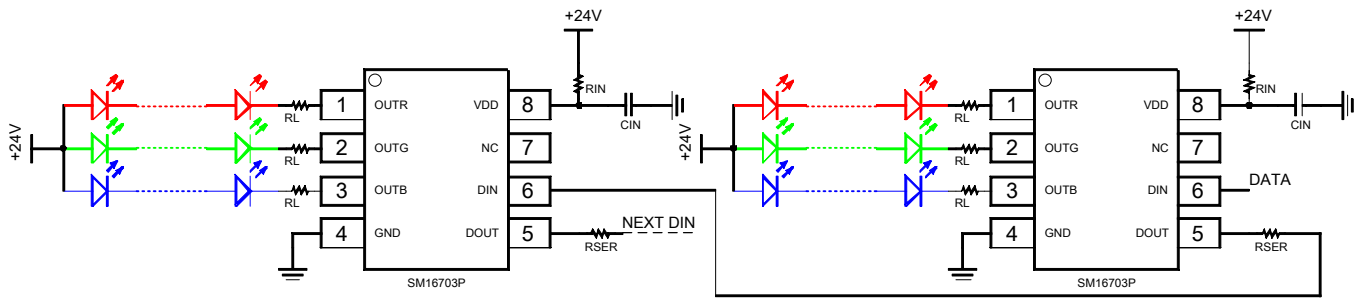
5V application, few peripheral components, transmission distance between two points can be 30m.

(2) 12V power supply, 3 LEDs



12V application, a 180ohmic resistor  $R_{SER}$  is recommended to cascaded at the signal output port to avoid the damage of the IC input port caused by the inverse connection between the electric plug and the signal line or between the power supply and signal line, the transmission distance between the two points of the 180ohmic resistor  $R_{SER}$  can be 10m.

(3) 24 power supply, 6 LEDs



24V application, a 470ohmic resistor  $R_{SER}$  is recommended to cascaded at the signal output port to avoid the damage of the IC input port caused by the inverse connection between the electric plug and the signal line or between the power supply and signal line, the transmission distance between the two points of the 470ohmic resistor  $R_{SER}$  can be 5m.

The typical application circuit of SM16703P includes  $V_{IN}$  (input voltage of power supply),  $R_{IN}$  (current-limiting resistor),  $C_{IN}$  (filter capacitor of chip VDD) and  $R_L$  (current-limiting resistor of R/G/B LED).

Chip power supply voltage VDD:  $VDD = V_{IN} - (I_{DD} + I_{IN}) * R_{IN}$

$I_{IN}$  is the operating current of the chip interior voltage-stabilizing circuit,  $I_{DD}$  is the chip quiescent current (excludes the voltage-stabilizing circuit current), the value of  $R_{IN}$  must be  $VDD > 4V$ .

The higher the  $R_{IN}$  is, the lower the system power consumption is, and the anti-interference capability is weak; the lower the  $R_{IN}$  is, the higher the system power consumption is, and the operating temperature is higher, therefore the  $R_{IN}$  should be selected compromisingly based on the system application environment in the design. The relation between  $V_{IN}$  and  $R_{IN}$  is given by:

$V_{IN}$	5V	6V	9V	12V	15V	18V	24V
$R_{IN}$	33	100	470	1K	1.5K	2K	3K

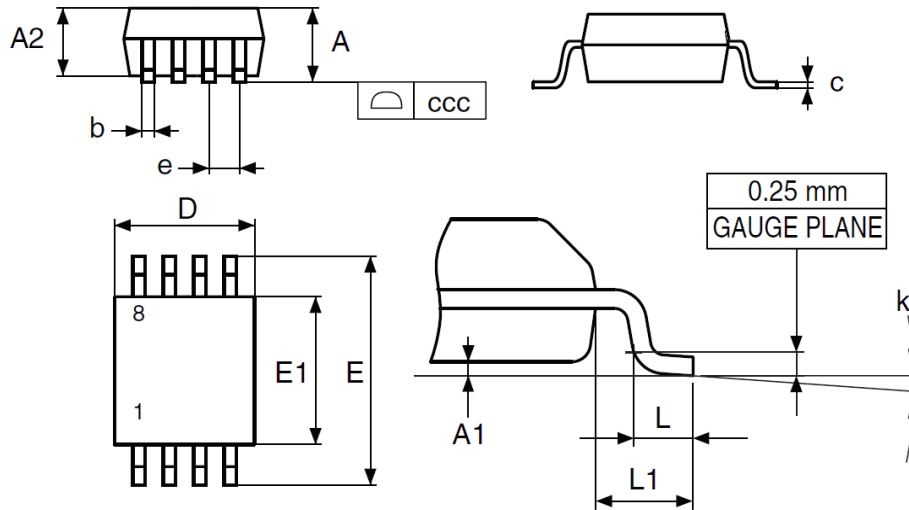
The load of the data output port DOUT of SM16703P equals to capacitor  $C_L$ , each data transmission cycle DOUT need to charge  $C_L$ , and the transient state of the charging current is 60mA approximately. Therefore, the voltage drop of the current-limiting resistor  $R_{IN}$  is increased transiently and the VDD voltage drops, the VDD voltage is stabilized through the filter capacitor  $C_{IN}$ .  $C_{IN}$  can be 0.1uF when the value of  $C_L$  doesn't exceed 1nF.

LED current-limiting resistor  $R_L$  :  $R_L = \frac{V_{IN} - N * V_{LED} - V_{DS}}{I_{LED}}$

$V_{IN}$  is input voltage,  $V_{LED}$  is voltage-drop of LED,  $V_{DS}$  is port voltage (constant current output when it's 1V),  $I_{LED}$  is port output current

**Package**

SOP8



DIMENSIONS						
REF.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.75			0.0689
A1	0.1		0.25	0.0039		0.0098
A2	1.25			0.0492		
b	0.28		0.48	0.011		0.0189
c	0.17		0.23	0.0067		0.0091
ccc			0.1			0.0039
D	4.8	4.9	5	0.189	0.1929	0.1969
E	5.8	6	6.2	0.2283	0.2362	0.2411
E1	3.8	3.9	4	0.1496	0.1535	0.1575
e		1.27			0.05	
h	0.25		0.5	0.0098		0.0197
k	0		8	0		8
L	0.4		1.27	0.0157		0.05
L1		1.04			0.0409	